V1.0



N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V} \,$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

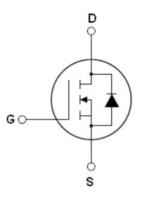
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS min@Tjmax}	710	V
R _{DS(ON)TYP} .	700	mΩ
I_D	5.8	Α
Qg	8.7	nC



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking	
NCE65N800I	TO-251-3L	NCE65N800I	



TO-251

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS=0} V)	V _{DS}	650	V
Gate-Source Voltage (VDS=0V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	5.8	A
Continuous Drain Current at Tc=100°C	I _{D (DC)}	4.06	A
Pulsed drain current (Note 1)	I _{DM (pluse)}	17.4	A
Maximum Power Dissipation(Tc=25℃)	P _D	70	W
Derate above 25°C		0.47	W/°C
Single pulse avalanche current (Note 2)	I _{AS}	1.5	A
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Drain Source voltage slope,V _{DS} ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55+175	°C

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Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance,Junction-to-Case(Maximum)	R _{thJC}	2.14	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	650			V
Zero Gate Voltage Drain Current(Tc=25°ℂ)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm20V, V_{DS}=0V$			±200	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250uA$	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.9A		700	800	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		47		Ω
Input Capacitance	C _{lss}	.,		314		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V,		18		pF
Reverse Transfer Capacitance	C _{rss}	F=1MHz		3.5		pF
Total Gate Charge	Qg			8.7		nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =3A, V _{GS} =10V		1.7		nC
Gate-Drain Charge	Q_{gd}			3.0		nC
Gate plateau voltage	Vgp			5.1		V
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	tr	V_{DD} =480 V , I_D =3 A ,		4		nS
Turn-Off Delay Time	t _{d(off)}	R_G =4 Ω , V_{GS} =10 V		50		nS
Turn-Off Fall Time	t _f			10		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T 05°0			5.8	Α
Pulsed-Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			17.4	Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =5.8A,V _{GS} =0V		0.9	1.1	V
Reverse Recovery Time	t _{rr}	T: 05°0 L 0A		195		nS
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _F =3A,		0.68		uC
Peak reverse recovery current	I _{rrm}	di/dt=100A/μs		7		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V, RG=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

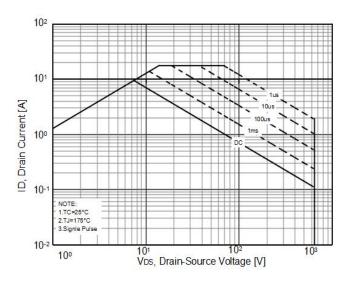


Figure 3. Output characteristics

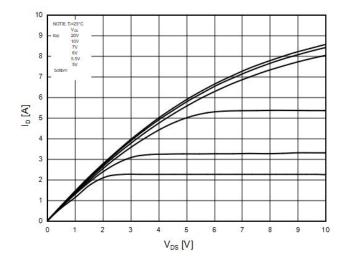


Figure 5. Static drain-source on resistance

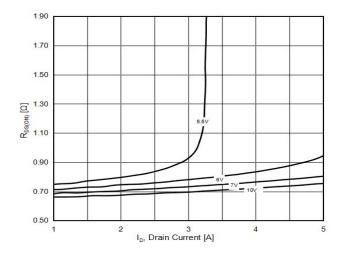


Figure 2. Source-Drain Diode Forward Voltage

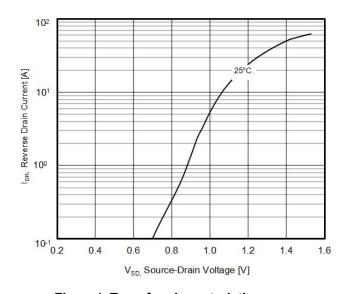


Figure 4. Transfer characteristics

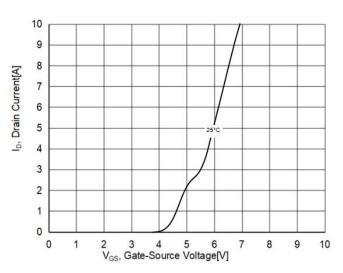


Figure 6. R_{DS(ON)} vs Junction Temperature

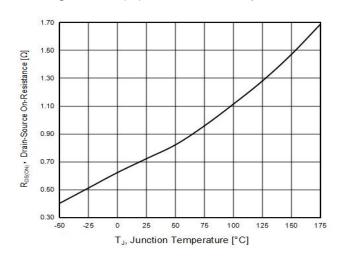




Figure 7. BV_{DSS} vs Junction Temperature

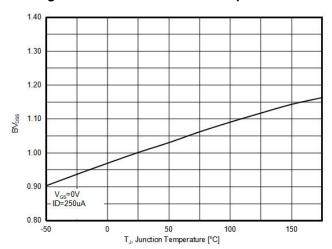


Figure 8. Maximum I_D vs Junction Temperature

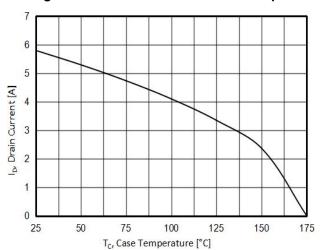


Figure 9. Gate charge waveforms

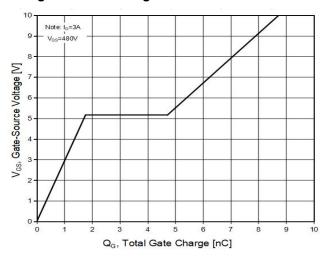
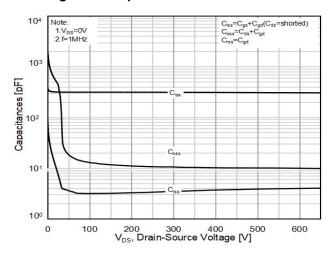


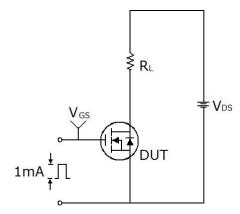
Figure 10. Capacitance

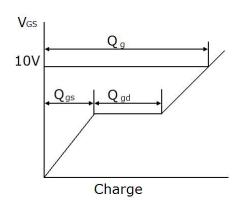




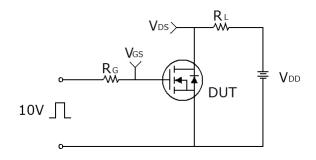
Test circuit

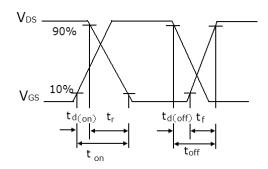
1) Gate charge test circuit & Waveform



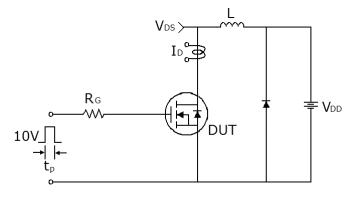


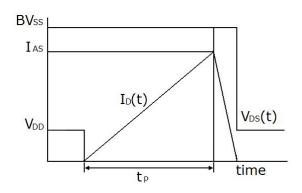
2) Switch Time Test Circuit:





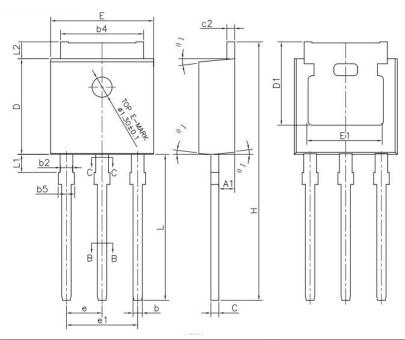
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-251-3L-P Package Information



Symbol	Dimensions	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.		
А	2.20	2.35	0.087	0.093		
A1	0.90	1.10	0.035	0.043		
b	0.56	0.69	0.022	0.027		
b1	0.55	0.65	0.022	0.026		
b2	0.77	0.90	0.030	0.035		
b3	0.76	0.86	0.030	0.034		
b4	5.23	5.43	0.206	0.214		
b5		1.05		0.041		
С	0.46	0.59	0.018	0.023		
c1	0.45	0.55	0.018	0.022		
c2	0.46	0.59	0.018	0.023		
D	6.00	6.20	0.236	0.244		
D1	5.20		0.205			
E	6.50	6.70	0.256	0.264		
E1	4.60	5.00	0.181	0.197		
е	2.24	2.34	0.088	0.092		
e1	4.47	4.67	0.176	0.184		
Н	16.18	16.78	0.637	0.661		
L	9.00	9.60	0.354	0.378		
L1	0.95	1.35	0.037	0.053		
L2	0.90	1.25	0.035	0.049		



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